

Thursday, February 13, 2014





#### **ATS At A Glance**

Proudly Serving the Electronics Industry for over 24 years



Mechanical and Thermal Design
Services

Instrumentation and Control Systems

Manufacturing Services and Global Sourcing

**Compliance Testing** 

**Training Programs** 





#### Role of ATS in Electronics Market

Electronics Market - OEM or CM

Electronics cooling and packaging issues encountered:

- Telecomm
- Datacomm
- Military
- Automotive
- Consumer
- Biomedical
- Others

PCB

Package

Innovation in Thermal Managament

OTS SOLUTIONS -

a broad spectrum of high performance right-cost solutions —ready to be applied

**CUSTOM SOLUTIONS —** 

Designed solutions to solve customers' specific application

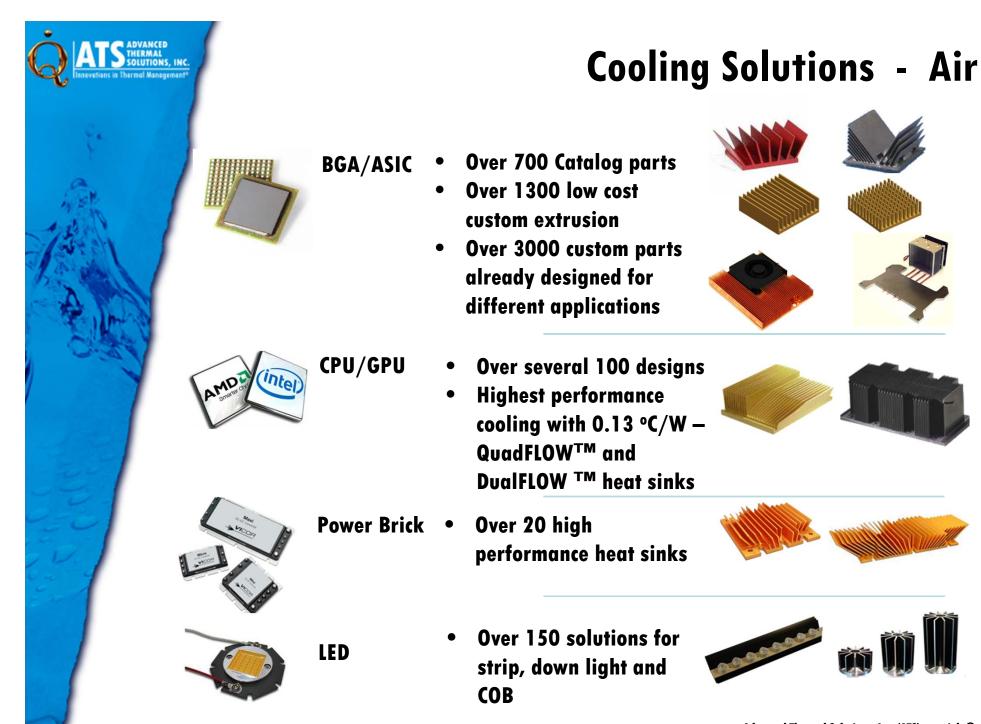
**DESIGN SERVICES —** 

providing state-of-the-art engineering services for OEM/CM

MANUFACTURING & SOURCING SERVICES -

providing domestic and international fabrication services

For cooling and packaging of electronic systems — ATS is uniquely resourced to address <u>air and liquid requirements</u> as well as mechanical packaging of the electronics market.





## **Cooling Solutions - Air**





DSP/TSOP/ DIP/etc.

- Over 2000 heat sinks with tape-on
- Over 108K push-pin heat sinks





**TO Packages** 

 Over 100 board level heat sinks







**LGA Devices** 

 Over 100 board level heat sinks







**Extrusion Profiles** 

 ATS offers an array of extrusion profiles ready for manufacturing a variety of heat sinks





Heat Sink Attachment



**Thermal Tape** 



**Push Pin** 



**Z**-clip



maxiGRIP<sup>TM</sup>



# **ATS Offers**: • Tape On • Z-clip • Push-pin • maxiGRIP™ superGRIP<sup>TM</sup> Z-Clip **Push Pin** $\textbf{superGRIP}^{\textbf{TM}}$ maxiGRIP<sup>TM</sup>

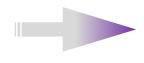
#### **ATS Heat Sink Attachment**

Clip-On System -Most Popular

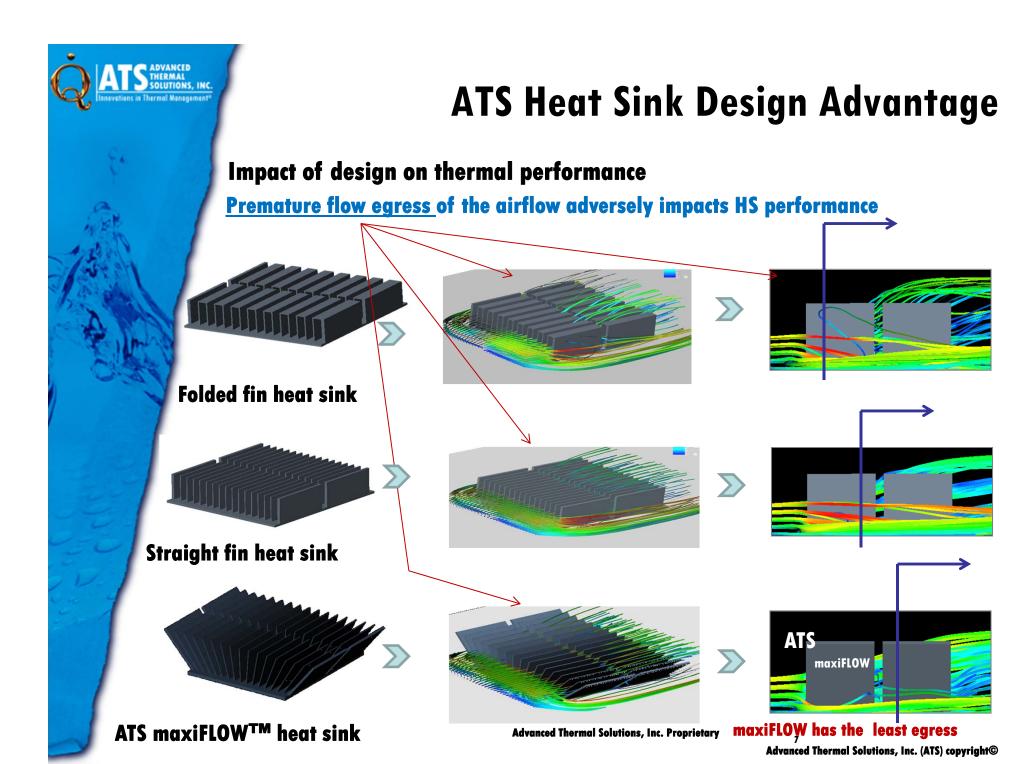




Features	ATS maxiGRIP™	Competition
BGA Solution	Yes	Yes
TIM	Phase change (+++)	Tape-on
Attachment	Frame & Spring Clips (applies load and retains the HS) (+++)	Tape-on (FC holds the HS from falling)
Removal/Installation	Super Easy — can be done by hand (++)	Requires a tool and FC often breaks
Temperature Stability	Plastic and SS spring clip — provides high degree of Temp stability (++)	Plastic clip only — the material yields with time and temperature
Thermal Performance	Superior (+++)	Average
Keep-out Area	Comparable	Comparable (+)
Cost	Comparable	Comparable

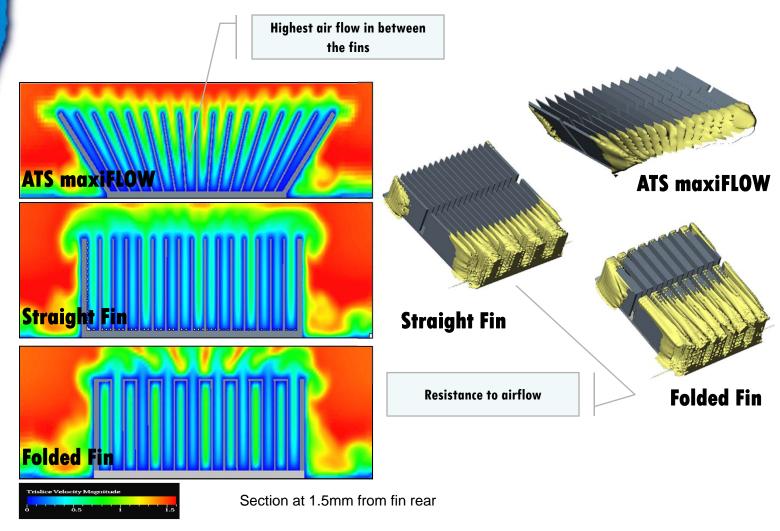


superGRIP $^{\text{TM}}$  - the next generation of heat sink attachment — highest strength with the least keep-out area





# **ATS Heat Sink Design Advantage**



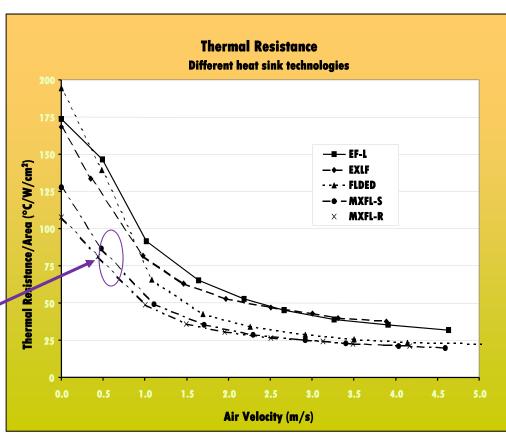
maxiFLOW<sup>TM</sup> exhibits the highest flow speed thru the fin field with the least flow stagnation, hence superior performance



# **ATS Heat Sink Design Advantage**

#### Highest performance heat sink in the market

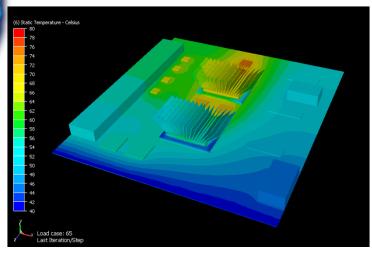




Source: F. Forghan, et. al., 200



# ATS Heat Sink Design Advantage Superior Cooling



PCB with Two maxiFLOWs in Series

(6) Static Temperature - Celsius 85 83.2				
81.4				
79.6				
77.8				
76				
74.2				
72.4				
70.6				
68.8				
65.2				1
63.4		V/V		
61.6		CONTRACTOR OF THE PARTY OF THE		
59.8				
58				
- 56.2	- Anuni	MINING A		
54.4	Sept.			
52.6		- STATE OF THE PARTY OF THE PAR		
50.8				
49				
47.2			1	
45.4				
43.6				
41.8				
40				
γ				
x Load case: 64				

**PCB** with Two Straight Fins in Series

	Upstream Heat Sink		Downstream Heat Sink		
	T <sub>i</sub> Rise over amb.	Heatsink T.R.	T <sub>i</sub> Rise over amb.	Heatsink T.R.	
maxiFLOW	24.7	0.97	35.3	0.98	
Straight Fin	27.4	1.14	42.4	1.16	

Air flow: 200LFM
Air Temp: 40°C
Channel height: 25mm
maxiFLOW and straight fin
HSs are of equivalent height,
fin number, fin thickness, and
base dimensions. Material is
aluminum & TIM is identical
in both cases.

 $\sim$ 10-17% In Temperature Reduction

# **IGBT High Power Devices**

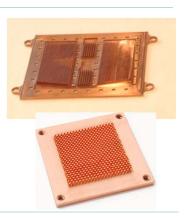
# **Cooling Solutions - Liquid**

ATS offers the least thermal resistance cold plate for IGBTs



Forced Thermal Spreader, up to 1000 W/cm<sup>2</sup>

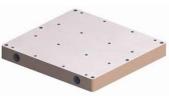
**Copper and aluminum** cold plates for high power CPU and ASICs



#### **Complete Liquid Cooling Loop Offering**



iFLOW-200™ for cold plate Characterization



**Cold plate for device** cooling



**Chillers for** conditioning the coolant



Flow controllers and leak detection



**Heat exchangers** for cooling of the coolant.



## **Thermal Test Equipment**

Temperature Velocity Pressure Wind Tunnels
- Air Flow
Simulation

Airflow and Heat Flux Controllers

Application
Specific Test
Equipment

ATVS=family







PTM-100



**IQ-200** 



CWT-family



**CLWT-family** 



**BWT-100** 



**1FLOW-200** 



**WTC-100** 



**FSC-200** 



**HFC-100** 



**DAC-200** 



**CIP-1000** 



**thermVIEW** 



# **Heat Pipe** TEC **Modules** TEC **Assemblies Chillers** TIMS Heat **Exchanger**

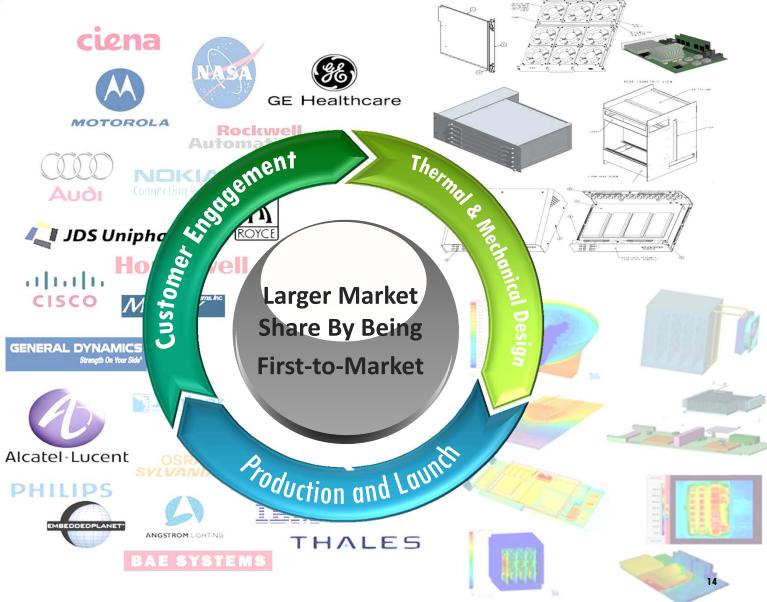
### **Cooling Solution Accessories**

- ATS Offers an array of OTS and custom designed heat pipes for a variety of applications
- ATS offers a host of high reliability TEC modules ranging from 5 to 340W cooling capacity
- ATS offers a broad range of air and liquid cooled TEC assemblies with cooling capacity of 1kW
- ATS offers several chillers with TEC as well as compressor based ones to address diverse needs of the market
- ATS offers a host of TIMs ranging from grease, tape, phase change and gap fillers.
- ATS offers nine different liquid-to-air heat exchangers for different cooling requirements



#### **Design Services**

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#### **What Differentiates ATS**

ATS	Competition
ATS heat sink products are offered from basic to state-of-the-art in cooling .	Basic products that are offered by 100s of companies across the globe.
ATS heat sinks provide the best thermal performance in a given volume.	No company can compete with what an ATS heat sink can do for cooling of a device.
Engineered and patented solutions.	Off-the-shelf products, easily sourced globally.
Strong engineering and manufacturing offering — uniquely positioned to solve customers problems right-the-first-time with the highest accuracy.	The largest company (Aavid) is heavily manufacturing focused - smaller companies can run first order CFD simulations.
ATS has a complete offering — Design, Manufacturing, Training, Testing and Testing Equipment in addition to custom and off-the-shelf products <i>truly a one-stop shop</i> .	There are over 5000 companies in the heat sink arena, with a "pass-thru" approach to thermal management — no company has the offering as ATS.
ATS is committed to R&D by developing and improving thermal management products in different verticals.	Commodity, low cost products that are readily available across the globe with no innovation and investment to develop new technology.



#### Testimonial — Why Partner With ATS

- **▶** Best thermal engineering I have seen in my career <u>Dialogic Corporation</u>
  - **▶** Your products are "Enabling Technology" <u>Siemens Corporation</u>
- "The clip-on solutions are the best on the market it is God sent"
- Alcatel-Lucent Corporation
  - "your maxiFLOW<sup>TM</sup> heat sink is the best performing heat sink on the market" <u>HP Corporation</u>
- "We would never use tape-on or epoxy for heat sink attachment your clip-on solution is a game changer" <u>Infinera Corporation</u>
  - "You are the only company whose thermal performance data matches what we test in the lab" IBM Corporation
- "When I come to ATS and engage your engineers and see your facility, I feel I have come to Mini Bell Labs" <u>Celestica Corporation</u>
  - "Your design capabilities and engineered solutions are unmatched in the industry" Starent Corporation (now Cisco)



#### **ATS Beliefs** -

#### In Pursuit of Excellence Best in Class Customer Service

- Founded in 1989 to serve the thermal management market.
- 50+ employees with extensive experience in thermal management and mechanical packaging of electronics.
- Experimental and computational labs with the latest software tools and state-of-the-art testing equipment.
- Company holds 8 patents with 9 in pending stages.
- Engineering and sales offices in U.S. and Europe.
- Worldwide manufacturing and distribution
- ISO 9001:2008 certified quality management system.
- Manufacturing and distribution centers in the US and Asia.



**Administrative and Engineering Office** 



Manufacturing Building

Advanced Thermal Solutions Inc. (ATS) - A Partnership with Success